



Product Change Notification

113255 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 113255 - 00
Change Title: Intel® Storage Server System JBOD2312S2SP
PCN 113255-00, Product Design, Label,
Update Power Distribute Board, SAS
Expander and Regulatory Label
Date of Publication: September 24, 2014

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material *:	October 9, 2014
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** Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.*

Description of Change to the Customer:

Intel has implemented the following changes on the Intel® Storage Server System JBOD2312S2SP:

1. Change the I²C address of the EEPROM on the Power Distribute Board (PDB) from 0xAE to 0xAC to avoid I²C address conflict with the front panel.
2. Update the SAS expander FW from version v0.13.0.6 to v0.13.0.8, and manufacturing (MFG) image version from 1.03 to 1.04, so that the SAS expander can read the system Enclosure ID from the EEPROM on the PDB with the updated I²C address.
3. Remove the Argentina safety logo (see Figure 1) from the regulatory labels on the system chassis and the side of the shipping carton to comply with Argentina regulation requests.



Figure 1: The removed Argentina safety logo

Customer Impact of Change and Recommended Action:

Intel recommends that customers validate the function and feature changes after receiving the systems.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
JBOD2312S2SP	927043	G79990-002	G79990-003

PCN Revision History:

Date of Revision:

September 24, 2014

Revision Number:

00

Reason:

Originally Published PCN